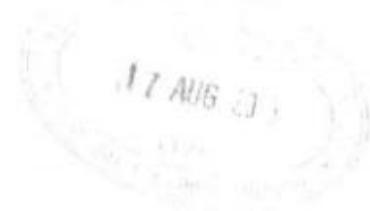


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ELECTRICAL MEASUREMENT
AND ANALOGUE ELECTRONICS

June/July 2016
Time: 3 hours



THE KENYA NATIONAL EXAMINATIONS COUNCIL

DIPLOMA IN ELECTRICAL AND ELECTRONIC ENGINEERING
(INSTRUMENTATION OPTION)
(TELECOMMUNICATION OPTION)
(POWER OPTION)

MODULE I

ELECTRICAL MEASUREMENT AND ANALOGUE ELECTRONICS

3 hours

INSTRUCTIONS TO CANDIDATES:

You should have the following for this examination:
Drawing instruments;

Non-programmable electronic calculator;

Mathematical tables.

This paper consists EIGHT questions into TWO sections; A and B.

Answer any THREE questions from section A and any TWO questions from section B in the answer booklet provided.

All questions carry equal marks.

Maximum marks for each part of a question are as shown.

Candidates should answer the questions in English.

Page

certificate

House

AB

540

This paper consists of 5 printed pages.

Candidates should check the question paper to ascertain that all the pages are printed as indicated and that no questions are missing.

SECTION A: ELECTRICAL MEASUREMENTS

Answer any THREE questions in this section.

1. (a) Define the following system of units as applied in measurements:

 - absolute unit;
 - derived unit.

(2 marks)

(b) Derive the dimensions of the following quantities using the electrostatic system of units:

 - charge (Q);
 - current (I).

(8 marks)

(c) State **four** advantages of the MKS system of units in electrical measurements.

(4 marks)

(d) Using the LMTI system of units, derive the dimensional equations for:

 - EMF, $E = \frac{\text{work}}{\text{charge}}$ Coloumbs
 - magnetic flux density, $B = \frac{\text{Force}}{\text{current}}$ Ampere

(6 marks)

2. (a) Explain the following types of measurement errors:

 - environmental errors; due to ~~weather~~ ~~temperature~~ variation due to the ~~position~~ ~~by~~
 - instrumental errors; ~~due to the~~ ~~influence~~ of the ~~instrument~~
 - gross errors; ~~gross~~ due to ~~human~~ ~~error~~
 - residue errors; ~~errors~~ due to the ~~loss~~ ~~of~~ ~~accuracy~~ ~~Random~~ ~~deviations~~ ~~small~~ ~~and~~

(8 marks)

(b) State **three** detectors and their operational frequencies as commonly used for a.c. bridges.

(6 marks)

(c) Explain how the following factors affect precision measurement of medium resistance with wheatstone bridge:

 - temperature effects;
 - contact resistance;
 - thermo-electric effects.

(6 marks)

3. (a) State **three** causes of faults on a printed circuit board.

(3 marks)

(b) List five tools used in the repair and maintenance of electronic equipment.

(5 marks)

(c) Explain **three** points a service engineer should consider when fault finding on electronic equipment.

(6 marks)

(d) Outline **three** operational objectives and **three** cost objectives of good maintenance.

(6 marks)

~~(a)~~ Describe the term 'reliability' as applied in electrical measurements.

~~(b)~~ Explain the importance of the following in relation to reliability:

- (i) mean time between failures; *This is taken after the machine will serve for a ...*
(ii) mean time to failure; *To serve the purpose when in need of failure.*
(iii) availability. *The availability is a measure of the machine to serve the required purpose.* (6 marks)

(c) Table 1 shows the performance of ten pressure monitors, observed while operating for a period of 1200 hours. Every failed unit is replaced immediately. Determine the:

- (i) MTBF;
(ii) failure rate (10 marks)

Table 1

Unit Number	Time of Failure (hours)	Failure
1	650	1
2	420	1
3	130 and 725	2
4	585	1
5	630 and 950	2
6	390	1
7	No failure	0
8	880	1
9	No failure	0
10	220 and 675	2

- (a) State three reasons for the inaccuracies encountered in magnetic measurements. (3 marks)
- (b) Outline six methods of fault location in electronic systems. (6 marks)
- (c) Explain the following wattmeter errors:
(i) eddy current errors;
(ii) stray magnetic field errors. (6 marks)
- (d) Draw a labelled construction diagram of Hibbert's magnetic standard used in magnetic measurements. (5 marks)



SECTION B: ANALOGUE ELECTRONICS

Answer any TWO questions from this section.

V.2

(2x5) M+

6. (a) Explain how the following extrinsic semi-conductors are formed.

- (i) N-type; formed by adding pentavalent elements.
 (ii) P-type; formed by adding trivalent elements. (4 marks)

- (b) (i) State three applications of semi-conductor diodes
 (ii) With aid of voltage-current characteristics, describe the avalanche breakdown in a P-N junction diode. (10 marks)

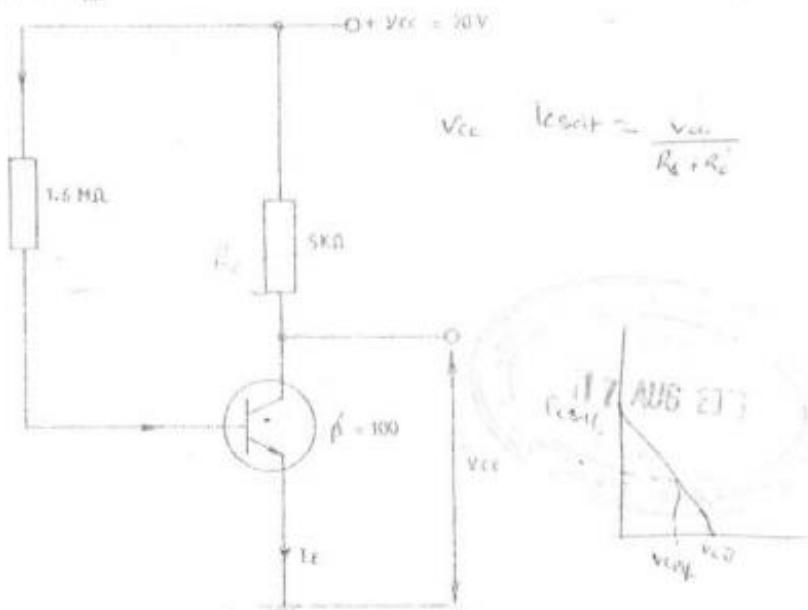
- (c) A silicon diode has a forward voltage drop of 1.5V and a forward d.c. current of 150 μA. It has a reverse current of 1.2 μA and a reverse voltage of 12 V. Determine for the diode the:
 $\mu_F = \sqrt{A R} = \frac{1}{2} \cdot \frac{150}{1.2 \times 10^{-6}} = 1.25 \times 10^9 \Omega$
 (i) forward resistance; μ_F
 (ii) reverse resistance, $\mu_R = \sqrt{A R} = \frac{12}{1.2 \times 10^{-6}}$ (6 marks)

7. (a) Draw equivalent two source biasing circuits using the transistor symbol for the following:

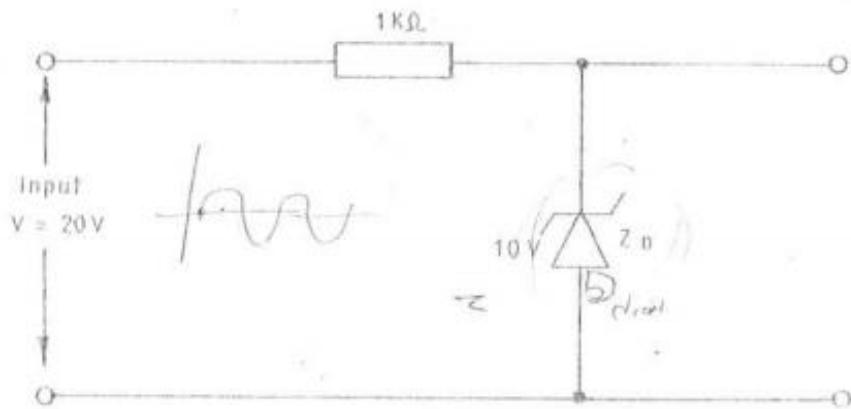
- (i) PNP transistor;
 (ii) NPN transistor. (4 marks)



- (b) Figure 1 shows an amplifier circuit.
 (i) Determine the d.c. operating point.
 (ii) Sketch the d.c. loadline.
 NB: neglect V_{in} . (12 marks)



- (c) State two advantages and **two** disadvantages of field effect transistors over bipolar junction transistors. (4 marks)
8. (a) State **three** advantages of bridge rectifier over bi-phase rectifier. (3 marks)
- (b) (i) With aid of circuit diagram and voltage waveforms, describe the operation of a single phase half wave rectifier feeding a purely resistive load.
(ii) Derive the expression for the output d.c. current for the rectifier in b(i). (11 marks)
- (c) Figure 2 shows a zener diode stabilizer. Determine the output voltage with no load current. (6 marks)



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